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**ON Semiconductor®** 

# FDMS9410-F085

# N-Channel PowerTrench<sup>®</sup> MOSFET

## **40 V, 50 A, 4.4 m**Ω

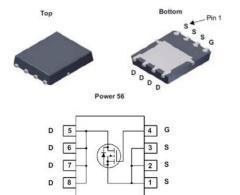
### Features

- Typical  $R_{DS(on)}$  = 3.7 m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 50 A
- Typical Q<sub>q(tot)</sub> = 24 nC at V<sub>GS</sub> = 10V, I<sub>D</sub> = 50 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

### Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12V Systems





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For current package drawing, please refer to the web-site at https://www.onsemi.com

#### MOSFET Maximum Ratings T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain-to-Source Voltage	40	V	
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
I <sub>D</sub>	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	50	Α
	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	39	mJ
P <sub>D</sub>	Power Dissipation		75	W
	Derate Above 25°C		0.5	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C
R <sub>0JC</sub>	Thermal Resistance, Junction to Case		2	°C/W
R <sub>0JA</sub>	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	50	°C/W

#### Notes:

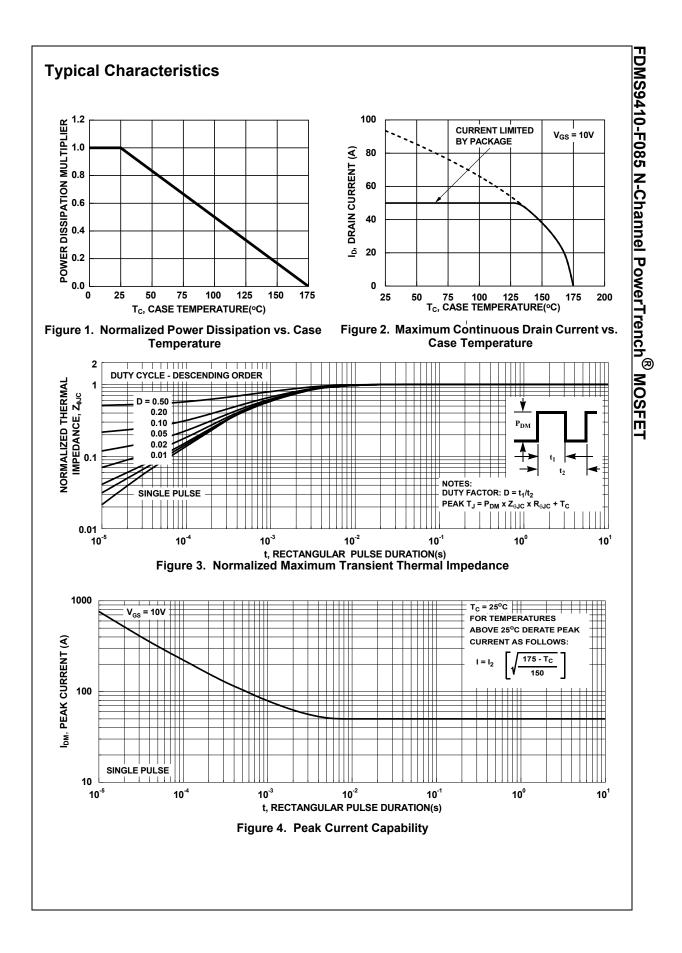
- 1: Current is limited by bondwire configuration.
- 2: Starting T<sub>J</sub> = 25°C, L = 0.1mH, I<sub>AS</sub> = 28A, V<sub>DD</sub> = 40V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche. 3:  $R_{0JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

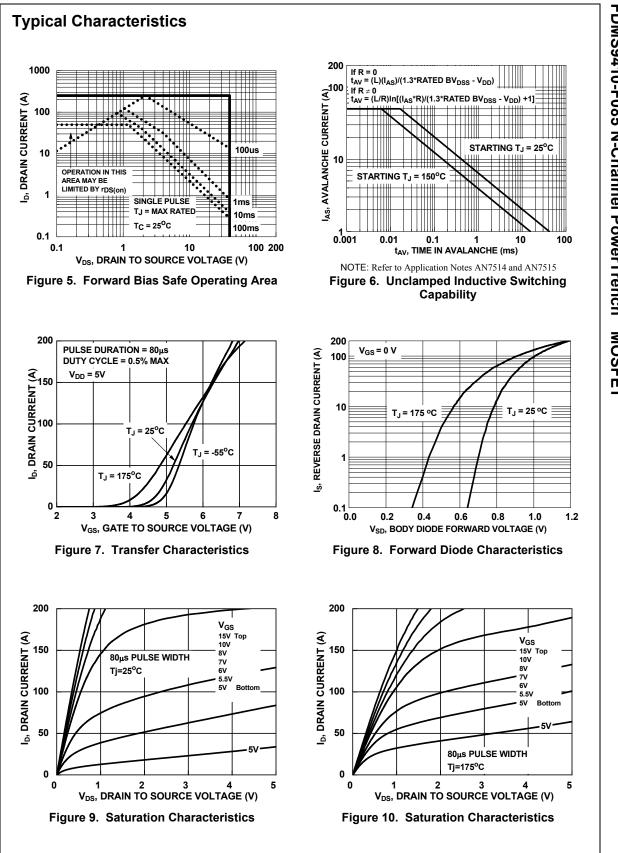
## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS9410	FDMS9410-F085	Power56	13"	12mm	3000units

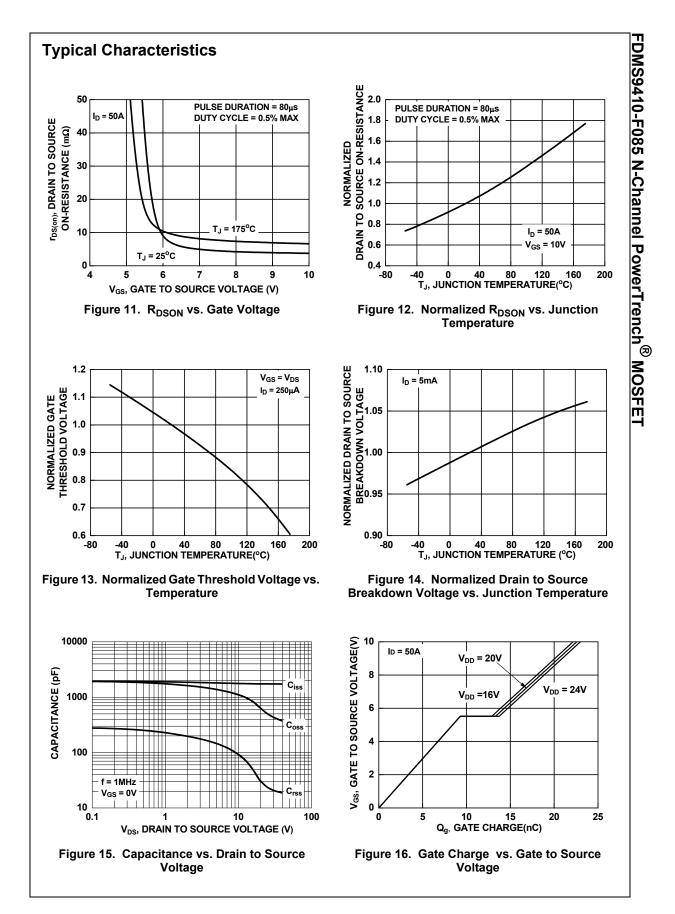
1

Symbol	Parameter	Test Conditions			Min.	Тур.	Max.	Units
Off Cha	racteristics							
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V	/ <sub>GS</sub> = 0V		40	-	-	V
	Desire to Oscilla de standa Oscilla et	$V_{DS}$ =40V, $T_{J}$ = 25°C			-	-	1	μA
IDSS	Drain-to-Source Leakage Current	V <sub>GS</sub> = 0V	$T_{\rm J} = 175^{\rm o}C$ (Note 4)		-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA	
On Cha	racteristics							
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub>	/ <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		2.0	3.2	4.0	V
	Drain to Source On Resistance	I <sub>D</sub> = 50A,	T <sub>J</sub> = 25 <sup>o</sup>	С	-	3.7	4.4	mΩ
R <sub>DS(on)</sub>		V <sub>GS</sub> = 10V	T <sub>J</sub> = 175	<sup>o</sup> C (Note 4)	-	6.6	7.9	mΩ
Dynami	c Characteristics							
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz		-	1790	-	pF	
C <sub>oss</sub>	Output Capacitance			-	620	-	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			-	32	-	pF	
R <sub>q</sub>	Gate Resistance	f = 1MHz			-	2.0	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	$V_{GS}$ = 0 to 10V $V_{DD}$ = 32V		-	24	36	nC	
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS}$ = 0 to 2V	/ I <sub>D</sub>	= 50A	-	3.3	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge				-	9.1	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge				-	4.5	-	nC
Switchi	ng Characteristics							
t <sub>on</sub>	Turn-On Time				-	-	27	ns
t <sub>d(on)</sub>	Turn-On Delay	$V_{DD}$ = 20V, I <sub>D</sub> = 50A, $V_{GS}$ = 10V, R <sub>GEN</sub> = 6 $\Omega$			-	12.1	-	ns
t <sub>r</sub>	Rise Time			-	5.9	-	ns	
t <sub>d(off)</sub>	Turn-Off Delay			-	18.8	-	ns	
t <sub>f</sub>	Fall Time			-	5.0	-	ns	
t <sub>off</sub>	Turn-Off Time			-	-	31	ns	
Drain-S	ource Diode Characteristics							
\/	Source to Drain Diade Valtage	I <sub>SD</sub> =50A, V <sub>GS</sub> = 0V I <sub>SD</sub> = 25A, V <sub>GS</sub> = 0V		-	-	1.25	V	
V <sub>SD</sub>	Source-to-Drain Diode Voltage				-	-	1.2	V
t <sub>rr</sub>	Reverse-Recovery Time	I <sub>F</sub> = 50A, dI <sub>S</sub>	$_{SD}/dt = 10$	0A/μs	-	45.5	59	ns
Q <sub>rr</sub>	Reverse-Recovery Charge	$V_{DD} = 32V$		-	33.2	43	nC	





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